

3 A High Voltage Schottky Barrier Rectifier

DESCRIPTION

This UPS3100e3 in the Powermite3[®] package is a high efficiency Schottky rectifier that is also RoHS compliant offering high current/power capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies. In addition to its size advantages, the Powermite3[®] package includes a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly and a unique locking tab act as an efficient heat path to the heat-sink mounting. Its innovative design makes this device ideal for use with automatic insertion equipment.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED) Symbol Unit Rating Value Peak Repetitive Reverse Voltage V_{RRM} Working Peak Reverse Voltage 100 V VRWM DC Blocking Voltage V_R **RMS Reverse Voltage** 70 V V_{R(RMS)} Average Rectified Output Current 3 I_0 А Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed 50 А I_{FSM} on Rated Load@ T_c =90 °C

THERMAL CHARACTERISTICS

T_{STG}

 $T_{\rm J}$

-55 to +150

-55 to +125

°C

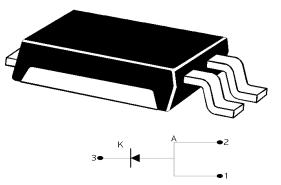
°С

| Thermal Resistance | | | | |
|---|------------------|-----|----------|--|
| Junction-to-Case (bottom) | R _{θJC} | 2.5 | °C/ Watt | |
| Junction to Ambient (1) | R _{0JA} | 65 | °C/ Watt | |
| (1) When mounted on FR-4 PC board using 2 oz copper with recommended minimum foot print | | | | |

Powermite 3[™]

Storage Temperature

Junction Temperature



KEY FEATURES

- Very low thermal resistance package
- RoHS Compliant with e3 suffix part number
- Guard-ring-die construction for transient protection
- Efficient heat path with Integral locking bottom metal tab
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
 - Compatible with automatic insertion
- Low profile-maximum height of 1mm

APPLICATIONS/BENEFITS

- Switching and Regulating Power Supplies.
 Silicon Schottky (bot corrier) rectifier for
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss with low ${\rm I}_{\rm RM}$
- Small foot print 190 X 260 mils (1:1 Actual size) See mounting pad details on pg 3

MECHANICAL & PACKAGING

- CASE: Void-free transfer molded thermosetting epoxy compound meeting UL94V-0
- FINISH: Annealed matte-Tin plating over copper and readily solderable per MIL-STD-750 method 2026 (consult factory for Tin-Lead plating)
- POLARITY: See figure (left)
- MARKING: S3100•
- WEIGHT: 0.072 gram (approx.)
- Package dimension on last page
- Tape & Reel option: 16 mm tape per Standard EIA-481-B, 5000 on 13" reel

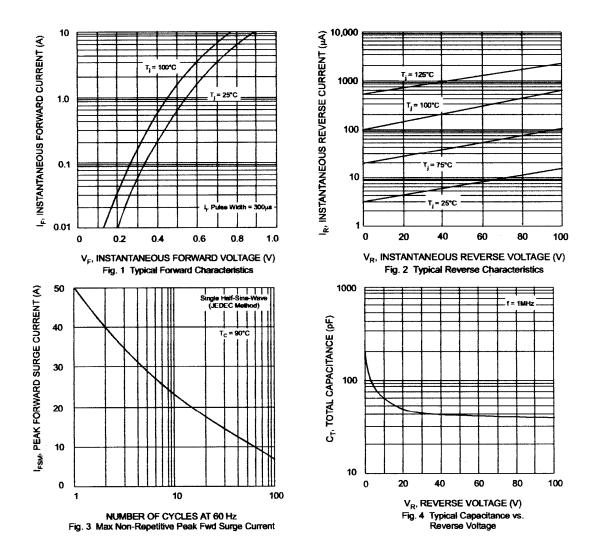
UPS3100E3



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| Parameter | Symbol | Conditions | Min | Тур. | Max | Units |
|--|-----------------|--|-----|------------------------------|------------------------------|----------|
| Forward Voltage (Note 1) | V _F | I _F = 3 A , T _j =25 °C I _F = 3 A , T _j =100 °C I _F = 6 A , T _j =25 °C I _F = 6 A , T _j =100 °C | | 0.72 0.60 0.79 0.68 | 0.76 0.64 0.83 0.72 | V |
| Reverse Break Down Voltage (Note 1) | V _{BR} | I _R = 0.2 mA | 100 | | | V |
| Reverse Current (Note1) | I _F | V _R = 100V, T _j = 25 °C V _R = 100V, T _j =100 °C | | 1.5 0.5 | 200 20 | μA mA |
| Capacitance | CT | V _R = 4 V; f = 1 MHz | | 85 | | pF |

Note: 1 Short duration test pulse used to minimize self - heating effect.

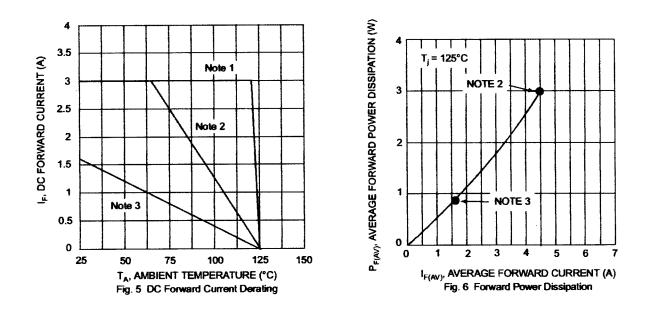


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UPS3100E3 ELECTRICALS



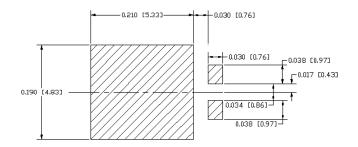
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Notes: 1. $T_A = T_{SOLDERING POINT}$, $R_{\Theta JS} = 2.5$ C/W, $R_{\Theta SA} = 0^{\circ}$ C/W.

- 2. Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\Theta JA}$ in range of 20-35°C/W.
- 3. Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout $R_{\Theta JA}$ in range of 65°C/W. See mounting pad below.

MOUNTING PAD DIMENSIONS



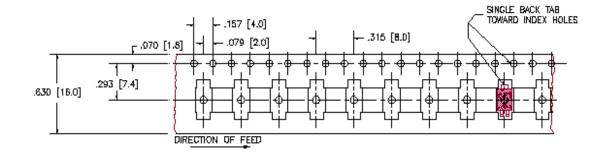
Mounting Pad Dimensions: inches [mm]

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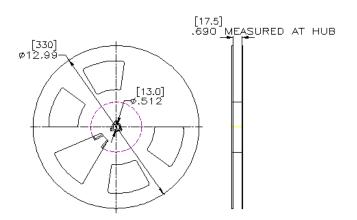


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TAPE & REEL



13 INCH REEL



MECHANICAL

UPS3100E3



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POWERMITE®3

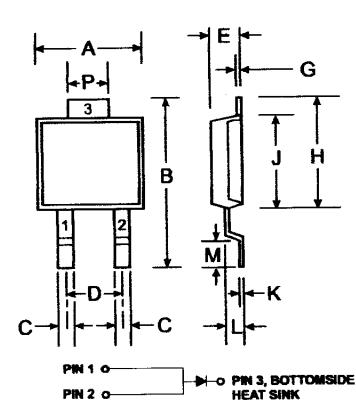
Min

Di-

İ

May

PACKAGE DIMENSIONS



| | | MAA | | |
|----------------------|----------|------|--|--|
| A | 4.03 | 4.09 | | |
| B | 6.40 | 6.61 | | |
| С | .889 NOM | | | |
| D | 1.83 NOM | | | |
| E | 1.10 | 1.14 | | |
| G | .178 NOM | | | |
| Н | 5.01 | 5.17 | | |
| J | 4.37 | 4.43 | | |
| K | .178 NOM | | | |
| L | .71 | .77 | | |
| M | .36 | .46 | | |
| Р | 1.73 | 1.83 | | |
| All Dimensions in mm | | | | |

Note: Pins 1 & 2 must be electrically connected at the printed circuit board.

Mouser Electronics

Authorized Distributor

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